



MAIL STOP RCE  
PATENT  
8053-1015

**IN THE U.S. PATENT AND TRADEMARK OFFICE**

In re application of

Takekazu TANAKA Conf. 1342

Application No. 10/602,044 Group 2814

Filed June 24, 2003 Examiner Alonzo Chambliss

SEMICONDUCTOR PACKAGE, AND  
PRODUCTION PROCESS FOR  
MANUFACTURING SUCH SEMICONDUCTOR  
PACKAGE

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

July 3, 2006

Sir:

In response to the Office Action mailed April 5, 2006,  
please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing  
of claims which begins on page 2 of this paper.

**Remarks** begin on page 7 of this paper.